

## 800V Tj175' Super Slim Ultra LVF Bridge with Top-Side Cooling Package

**Voltage**

**800 V**

**Current**

**25A**

### Features

- Oxide planar chip junction
- Low forward voltage drop ( $V_F@0.72V$ )
- Low leakage current ( $I_R@20\mu A$ )
- Lead free in compliance with EU RoHS 2.0
- Halogen-free according to IEC 61249 standard
- Fulfill Wettable Flank Capability
- Super slim@1.3mm thickness
- Panel Level Package Technology



**M12**



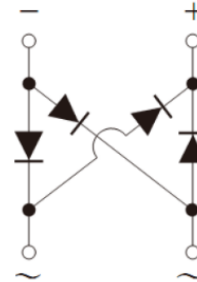
### Mechanical Data

- Case : M12 Package
- Terminals : Solderable per MIL-STD-750, Method 2026
- Approx. Weight : 0.7742 grams



### Application

- Power: Server / AI / Industrial
- PC Power: 80+Platinum Titanium
- Power: Redundant / Telecom
- Gaming Power: NB / PC
- PD > 120W



Key Parameters	
Parameter	Value
$V_{RRM}$	<b>800V</b>
$I_F(AV)$	<b>25A</b>
$I_{FSM}$	<b>350A</b>
$V_F@175^{\circ}C$	<b>0.72V</b>
$I_R$	<b>1uA</b>
<b>TJ max.</b>	<b>175°C</b>
<b>Package</b>	<b>M12</b>

**Maximum Ratings and Thermal Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS
Maximum Repetitive Peak Reverse Voltage		$V_{RRM}$	800	V
Maximum RMS Voltage		$V_{RMS}$	560	V
Maximum DC Blocking Voltage		$V_{DC}$	800	V
Maximum Average Forward Current	With heatsink	$I_{F(AV)}$	25	A
	Without heatsink		5.8(TBD)	
Peak Forward Surge Current : 8.3 ms Single Half Sine-Wave Superimposed On Rated Load	@ $T_A = 25^\circ\text{C}$	$I_{FSM}$	350	A
	@ $T_A = 125^\circ\text{C}$		280	
Peak Forward Surge Current : 1.0 ms Single Half Sine-Wave Superimposed On Rated Load	@ $T_A = 25^\circ\text{C}$	$I_{FSM}$	600	A
	@ $T_A = 125^\circ\text{C}$		500	
$I^2 t$ rating for fusing ( $t = 8.3\text{ms}$ )		$I^2 t$	508	$\text{A}^2\text{S}$
Typical Junction Capacitance Measured at 1 MHZ And Applied $V_R = 4\text{ V}$		$C_J$	170	pF
Typical Thermal Resistance (Note 1) (with heatsink)		$R_{\theta JA}$	6(TBD)	$^\circ\text{C/W}$
		$R_{\theta JL}$	3(TBD)	
		$R_{\theta JC}$	1(TBD)	
Operating junction and storage temperature range		$T_J, T_{STG}$	-55~175	$^\circ\text{C}$

**Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Forward Voltage	$V_F$	$I_F = 12.5\text{ A}, T_J = 25^\circ\text{C}$	-	0.88	0.92	V
		$I_F = 12.5\text{ A}, T_J = 125^\circ\text{C}$	-	0.75	-	
Reverse Current	$I_R$	$V_R = 800\text{ V}, T_J = 25^\circ\text{C}$	-	0.2	1	$\mu\text{A}$
		$V_R = 800\text{ V}, T_J = 125^\circ\text{C}$	-	20	-	

NOTES :

1. Mounted on a FR4,100x100x1.6mm ,2oz copper pad area .

TYPICAL CHARACTERISTIC CURVES

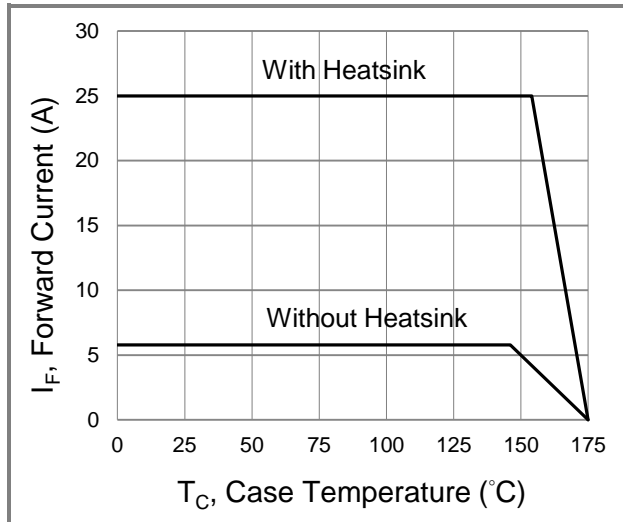


Fig.1 Forward Current Derating Curve

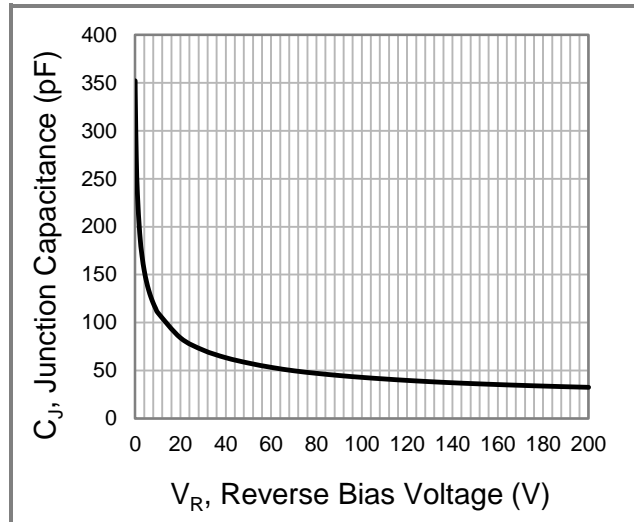


Fig.2 Typical Junction Capacitance

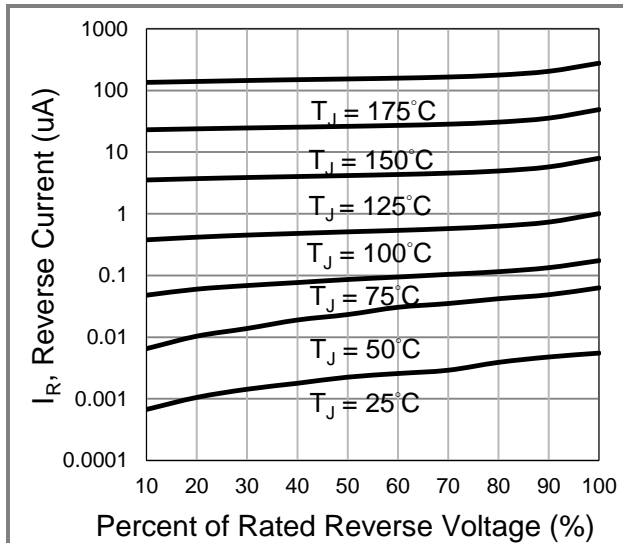


Fig.3 Typical Reverse Characteristics

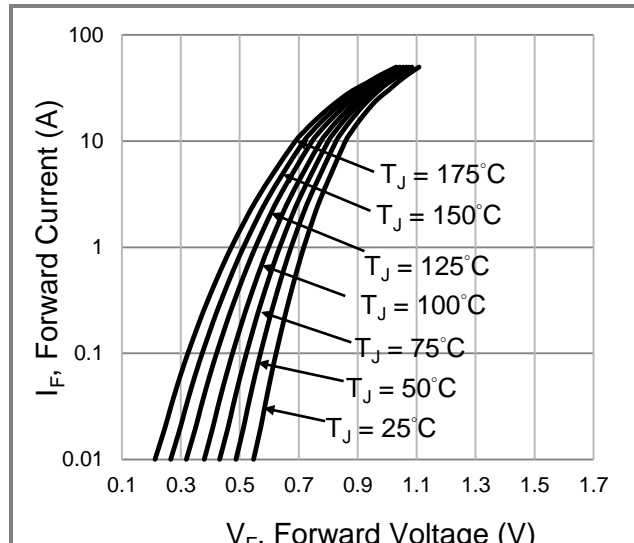


Fig.4 Typical Forward Characteristics

**Part No. Marking Code Version**

Approved Part No.	Package Type	Packing Type	Marking
PMQ2508HULV	M12	2K pcs / 13" reel	PMQ2508HULV

**Packaging Information**

M12 Dimension

Unit: inch(mm)

The image shows a technical drawing of an M12 package. The top view is a rectangle with dimensions D (total width) and e (distance between mounting pads). The side view shows the package height E and the mounting pad height L. The mounting pad width is labeled b. The distance from the mounting pad to the package edge is labeled C. The total package width is labeled A.

M12 Dimension.Unit:Inch (mm)	
Dim	Unit (mm)
	TPY
A	1.301
b	3.128
C	0.086
D	10.167
E	11.931
e	6.951
L1	0.803

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